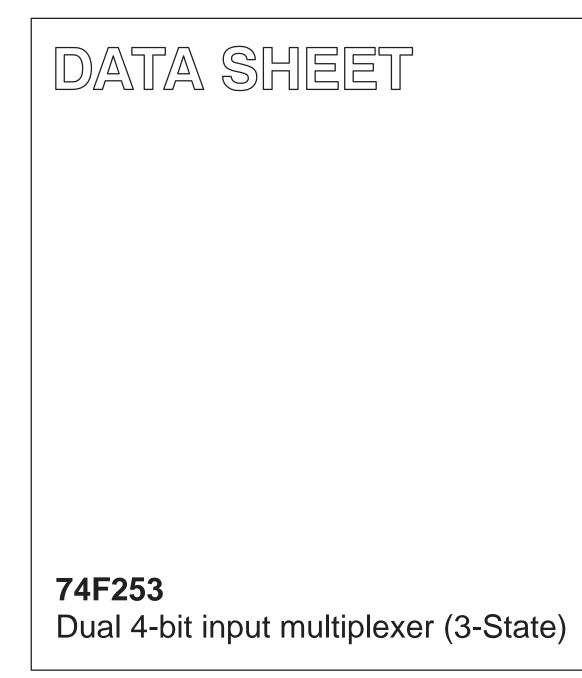
## INTEGRATED CIRCUITS



Product specification

1988 Nov 29

IC15 Data Handbook



HILIP

Philips Semiconductors

## 74F253

#### **FEATURES**

- 3-State outputs for bus interface and multiplex expansion
- Common select inputs
- Separate Output Enable Inputs

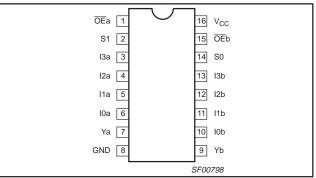
#### DESCRIPTION

The 74F253 has two identical 4-input multiplexers with 3-State outputs which select two bits from four sources selected by common Select inputs (S0, S1). When the individual Output Enable ( $\overline{OEa}$ ,  $\overline{OEb}$ ) inputs of the 4-input multiplexers are High, the outputs are forced to a high impedance (Hi-Z) state.

The 74F253 is the logic implementation of a 2-pole, 4-position switch; the position of the switch being determined by the logic levels supplied to the two common Select inputs.

To avoid exceeding the maximum current ratings when the outputs of the 3-State devices are tied together, all but one device must be in the high-impedance state. Therefore, only one Output Enable must be active at a time.

#### **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F253	7.0ns	12mA

## **ORDERING INFORMATION**

	COMMERCIAL RANGE			
DESCRIPTION	V <sub>CC</sub> = 5V ±10%, T <sub>amb</sub> = 0°C to +70°C	PKG DWG #		
16-pin plastic DIP	N74F253N	SOT38-4		
16-pin plastic SO	N74F253D	SOT109-1		

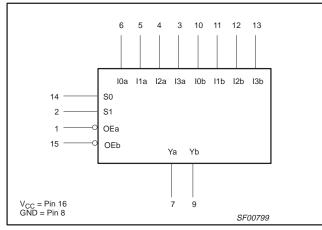
## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
l0a–l3a	Port A data inputs	1.0/1.0	20µA/0.6mA
l0b–l3b	Port B data inputs	1.0/1.0	20µA/0.6mA
S0, S1	Common Select inputs	1.0/1.0	20µA/0.6mA
OEa	Port A Output Enable input (active Low)	1.0/1.0	20µA/0.6mA
OEb	Port B Output Enable input (active Low)	1.0/1.0	20µA/0.6mA
Ya, Yb	3-State outputs	150/40	3mA/24mA

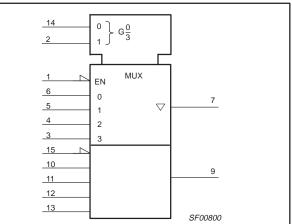
#### NOTE:

One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

#### LOGIC SYMBOL

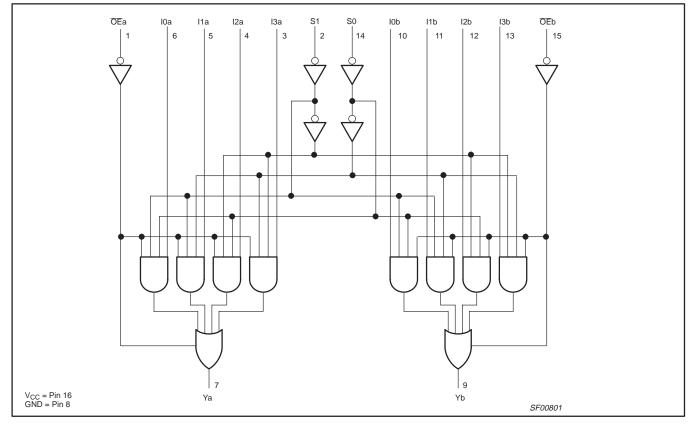


## **IEC/IEEE SYMBOL**



## 74F253

## LOGIC DIAGRAM



## **FUNCTION TABLE**

	INPUTS										
S0	S1	10	11	12	13	ŌĒ	Y				
Х	Х	Х	Х	Х	Х	Н	Z				
L	L	L	Х	Х	Х	L	L				
L	L	н	Х	х	Х	L	Н				
н	L	х	L	х	х	L	L				
н	L	х	н	х	х	L	Н				
L	н	х	Х	L	х	L	L				
L	н	х	х	н	х	L	Н				
н	н	х	Х	х	L	L	L				
н	н	х	Х	х	Н	L	Н				

NOTES:

H = High voltage level L = Low voltage level X = Don't care Z = High impedance "off" state

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#### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limit set forth in this table may impair the useful life of the device.

Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V
I <sub>IN</sub>	Input current	-30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	–0.5 to $V_{CC}$	V
I <sub>OUT</sub>	Current applied to output in Low output state	48	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature	-65 to +150	°C

## **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT		
STWBOL	PARAMETER	MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-3	mA
I <sub>OL</sub>	Low-level output current			24	mA
T <sub>amb</sub>	Operating free-air temperature range	0		70	°C

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETE	PARAMETER		TEST CONDITIONS <sup>NO TAG</sup>			TYP NO TAG	МАХ	UNIT
N/			$V_{CC} = MIN, V_{IL} = MAX,$	±10%V <sub>CC</sub>	2.4			V	
V <sub>OH</sub>	High-level output voltage	3	$V_{IH} = MIN, I_{OH} = MAX$		±5%V <sub>CC</sub>	2.7	3.3		V
V <sub>OL</sub>			$V_{CC} = MIN, V_{IL} = MAX,$		±10%V <sub>CC</sub>		0.35	0.50	V
	Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$		±5%V <sub>CC</sub>		0.35	0.50	V
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$				-0.73	-1.2	V
lı	Input current at maximur voltage	n input	$V_{CC} = MAX, V_I = 7.0V$					100	μA
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$					20	μΑ
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$					-0.6	mA
I <sub>OZH</sub>	Off-state output current High-level voltage applie	d	$V_{CC} = MAX, V_O = 2.7V$					50	μA
I <sub>OZL</sub>	Off-state output current Low-level voltage applied	d	$V_{CC} = MAX, V_O = 0.5V$					-50	μA
I <sub>OS</sub>	Short-circuit output curre	ent <sup>NO TAG</sup>	$V_{CC} = MAX$			-60		-150	mA
		I <sub>CCH</sub>		OEn=GND,	Sn=In=4.5V		10	16	mA
I <sub>CC</sub>	Supply current (total) I <sub>CCL</sub>		V <sub>CC</sub> = MAX OEn=Sn=In=GN		=GND		12	23	mA
			]	OEn=4.5V, Sr			14	23	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ . 3. Not more than one output should be shorted at a time. For testing  $I_{OS}$ , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

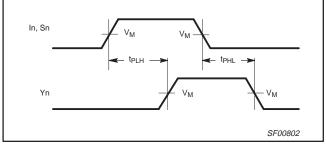
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## **AC ELECTRICAL CHARACTERISTICS**

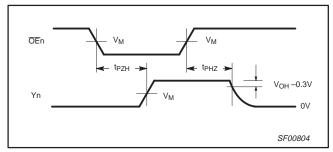
SYMBOL	PARAMETER	TEST CONDITION	$V_{CC} = +5V$ $T_{amb} = +25^{\circ}C$ $C_{L} = 50pF$ $R_{L} = 500\Omega$			V <sub>CC</sub> = +5 T <sub>amb</sub> = 0°C C <sub>L</sub> = R <sub>L</sub> =	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to Yn	Waveform NO TAG	3.0 3.0	4.5 5.0	7.0 7.0	3.0 3.0	7.5 8.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Sn to Yn	Waveform NO TAG	4.5 5.0	7.5 8.5	10.5 11.0	4.5 4.5	11.0 12.0	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	Waveform 2 Waveform 3	3.0 3.0	6.5 6.5	8.0 8.0	3.0 3.0	9.0 9.0	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable time from High or Low level	Waveform 2 Waveform 3	2.5 2.0	3.5 3.0	5.0 5.0	2.0 1.5	6.0 6.0	ns

## AC WAVEFORMS

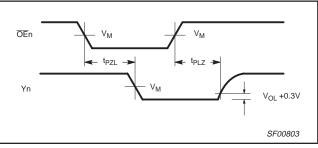
For all waveforms,  $V_{M}$  = 1.5V



Waveform 1. Propagation Deley, Data and Select to Output



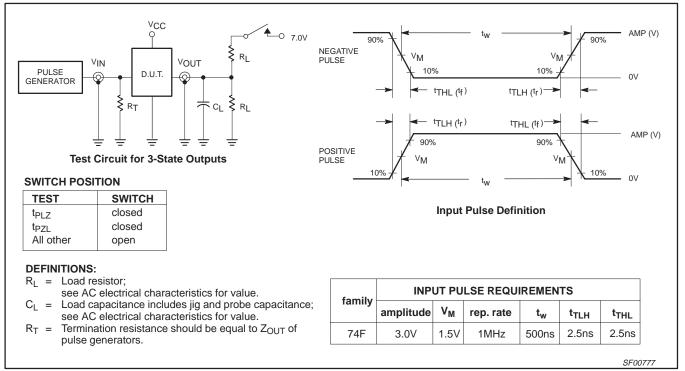
Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level

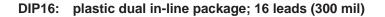


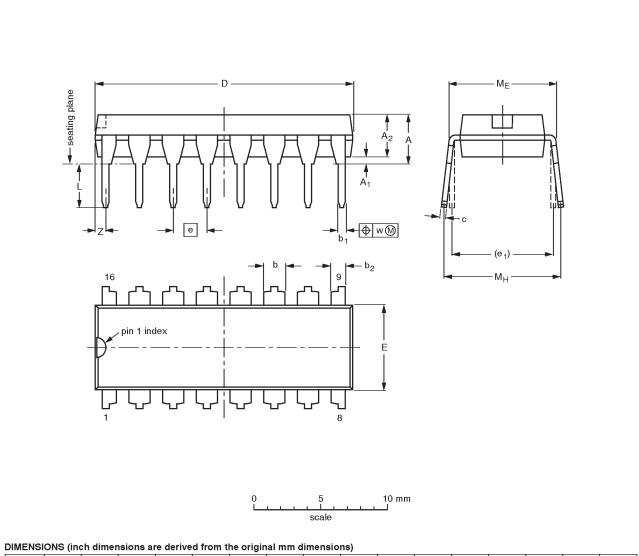
Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

## 74F253

#### **TEST CIRCUIT AND WAVEFORMS**







UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	о <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

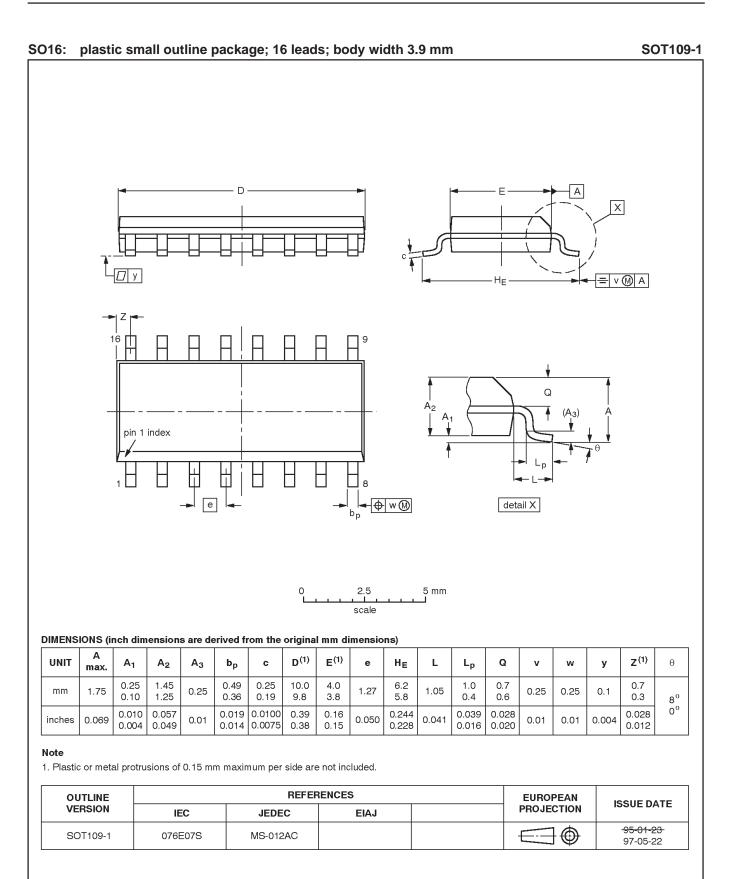
#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT38-4						<del>-92-11-17-</del> 95-01-14	

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SOT38-4



## 74F253

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition - Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Date of release: 10-98 9397-750-05105

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	• Catalo	<u> </u>		-								
	Functi			The 74F253 has two identical 4-input multiplexers	with 3-State outputs which se	elect two bits from four						
	Catalo			sources selected by common Select inputs (S0, S1).	1							
	Systen			of the 4-input multiplexers are High, the outputs are	-	-						
_	• <u>Cross</u> -											
	• Packag	· · · · · · · · · · · · · · · · · · ·		The 74F253 is the logic implementation of a 2-pole		ion of the switch being						
_	• End of inform			determined by the logic levels supplied to the two c	common Select inputs.							
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				Features								

- 3-State outputs for bus interface and multiplex expansion
- Common select inputs
- Separate Output Enable Inputs

# Applications

AN202\_1: Testing and specifying FAST logic (date 01-Jun-87) AN2021\_1: Thermal considerations for FAST logic products (date 13-Mar-95) AN203\_2: Test Fixtures for High Speed Logic (date 02-Apr-98) AN216\_2: Arbitration in shared resource systems (date 18-Jul-88)

# Datasheet

<u>Type</u> number	<u>Title</u>	Publication release date	Datasheet status	Page count	File size (kB)	Datasheet
74F253	Dual 4-bit input multiplexer (3- State)	11/29/1988	Product specification	10	89	Download

# Blockdiagram(s)

Block diagram of N74F253N

# Parametrics

Type number	Package	Description	Propagation Delay(ns)	Voltage	of	Power Dissipation Considerations	Logic Switching Levels	Output Drive Capability
N74F253D	<u>SOT109</u> (SO16)	Dual 4-Input Multiplexer (3-State)	6~10	5 Volts +	16	None	TTL	Low
N74F253N	<u>SOT38-4</u> (DIP16)	Dual 4-Input Multiplexer (3-State)	6~10	5 Volts +	16	None	TTL	Low

# Products, packages, availability and ordering

<u>Type</u> <u>number</u>	<u>North</u> <u>American</u> <u>type</u> <u>number</u>	Ordering code (12NC)	Marking/Packing Discretes packing info	Package	Device status	Buy online
N74F253D	N74F253D	9337 567 30602	Standard Marking * Tube (Signetics)	<u>SOT109</u> (SO16)	Full production	order this -
	N74F253D- T	9337 567 30623	Standard Marking * Reel Pack, SMD, 13" (Signetics)	<u>SOT109</u> (SO16)	Full production	order this -
N74F253N	N74F253N	9337 567 20602	Standard Marking * Tube (Signetics)	<u>SOT38-4</u> (DIP16)	Full production	order this -

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<u>74F253</u> links to the similar products page containing an overview of products that are similar in function or related to the type number(s) as listed on this page. The similar products page includes products from the same catalog tree(s), relevant selection guides and products from the same functional category.

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